Docket No.

273631US0PCT

JC06 Rec'd PCT/PTO 0 9 SEP 2005

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

IN RE APPLICATION OF:

Kazuyuki NAKANISHI, et al.

SERIAL NO:

10/538,222

GAU:

FILED:

June 9, 2005

EXAMINER:

FOR:

SEMICONDUCTOR ELEMENT HEAT DISSIPATING MEMBER, SEMICONDUCTOR DEVICE USING SAME,

AND PRODUCTION METHOD THEREOF

INFORMATION DISCLOSURE STATEMENT UNDER 37 CFR 1.97

COMMISSIONER FOR PATENTS ALEXANDRIA, VIRGINIA 22313

Applicant(s) wish to disclose the following information.

REFÉRENCES

- The applicant(s) wish to make of record the references listed on the attached form PTO-1449. Copies of the listed references are attached, where required, as are either statements of relevancy or any readily available English translations of pertinent portions of any non-English language references.
- ☐ A check or credit card payment form is attached in the amount required under 37 CFR §1.17(p).

RELATED CASES

- Attached is a list of applicant's pending application(s), published application(s) or issued patent(s) which may be related to the present application. In accordance with the waiver of 37 CFR 1.98 dated September 21, 2004, copies of the cited pending applications are not provided. Cited published and/or issued patents, if any, are listed on the attached PTO form 1449.
- ☐ A check or credit card payment form is attached in the amount required under 37 CFR §1.17(p).

CERTIFICATION

- ☐ Each item of information contained in this information disclosure statement was first cited in any communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of this statement.
- ☐ No item of information contained in this information disclosure statement was cited in a communication from a foreign patent office in a counterpart foreign application or, to the knowledge of the undersigned, having made reasonable inquiry, was known to any individual designated in 37 CFR §1.56(c) more than three months prior to the filing of this statement.

DEPOSIT ACCOUNT

Please charge any additional fees for the papers being filed herewith and for which no check or credit card payment is enclosed herewith, or credit any overpayment to deposit account number 15-0030. A duplicate copy of this sheet is enclosed.

Respectfully submitted,

OBLON, SPIVAK, McCLELLAND, MAIER & NEUSTADT, P.C.

Norman F. Oblon

Registration No. 24,618

Customer Number

Tel. (703) 413-3000 Fax. (703) 413-2220 (OSMMN 05/03)

Surinder Sachar

Registration No. 34,423

U.S. PCT Application Serial No.: 10/538,222 Docket No.: 273631US0PCT

STATEMENT OF RELEVANCY

1) References <u>AA, AB and AO-AS</u> have been cited in the International Search Report. Copies of these references are being submitted herewith only when not automatically provided by the International Searching Authority.								
2) Reference have been cited in the corresponding Search Report. A copy of this reference is being submitted herewith.								
3) References <u>AT-AW and AZ</u> are discussed in the specification. A copy of these references is being submitted here with.								
4) Referenceis additional prior art known to Applicant. A copy of these references is being submitted herewith.								

Form PTO 1449	U.S. DEPARTMENT OF COMMERCE			ATTY DOCKET NO.		SERIAL NO.			
(Modified)		PATENT AND TRAI	DEMARK OFFICE	273631US0PCT		10/538,222			
·				APPLICANT					
LIST OF REFERENCES CITED BY APPLICANT				Kazuyuki NAKANISHI, et al.					
				FILING DATE		GROUP			
				June 9, 2005					
U.S. PATENT DOCUMENTS									
EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUB FILING DATE CLASS IF APPROPRIATE			
	AA	5,412,160	05/02/95	YASUMOTO, Takaaki et al. (Equivalent of JP 6-326431)					
	AB	4,971,667	11/20/90	YAMAZAKI, Shunpei et al. (Equivalent of JP 1-286911)					
	AC								
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	AE								
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	AL								
	AM								
	AN								
FOREIGN PATENT DOCUMENTS									
		DOCUMENT NUMBER	DATE	COUNTRY		TRANSLATION YES NO		SLATION NO	
	AO	63-124555	05/28/88	JP(with English abstract)		; = 3		NO	
	AP	2001-332798	11/30/01	JP(with English abstract)				NO	
, , , , , , , , , , , , , , , , , , , 	AQ	62-180073	08/07/87	JP(with English abstract)				NO	
,	AR	62-157602	07/13/87	JP(with partial English translation)				NO	
	AS	33463/1986	02/28/86	JP(with partial English translation)				NO	
	ΑT	7-99268	04/11/95	JP(with English abstract)				NO	
	AU	11-292692 •	10/26/99	JP(with English abstract)				NO	
, ,	ΑV	2000-174166 -	06/23/00	JP(with English abstract)				NO	
·	AW	10-32213 ~	02/03/98	JP(with English abstract)				NO	
	AX								
	AY								
OTHER REFERENCES (Including Author, Title, Date, Pertinent Pages, etc.)									
	ΑZ		R DEVICES", S	DIAMOND HEAT SPREADERS FOR Solid-State Electronics, Vol. 42, No. 12,	Additional References sheet(s) attached				
Examiner					Date Considered				
*Examiner: Initial if reference is considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.									